

Sheet 1 of 3							
FORM PTO 1448 (modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE LIST OF REFERENCES CITED BY APPLICANT(S) (Use several sheets if necessary) Date Submitted to PTO: July 17, 2003				ATTY DOCKET NO. 2003_0979		SERIAL NO. NEW	
				APPLICANT Akihisa HONGO et al.			
				FILING DATE July 17, 2003		GROUP	
U.S. PATENT DOCUMENTS							
*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
LV	AA	5,723,387	3-1998	Chen			
	AB	6,027,630	2-2000	Cohen			
	AC	6,110,345	8-2000	Iacoponi			
	AD	6,294,059	9-2001	Hongo et al.			
	AE	6,413,436	7-2002	Aegerter et al.			
	AF	6,254,760	7-2001	Shen et al.			
	AG	6,258,220	7-2001	Dordi et al.			
	AH	6,333,275	12-2001	Mayer et al.			
LV	AI	5,897,379	4-1999	Ulrich et al.			
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
LV	AJ	8-37143	6/1996	JP			Abstract
	AK	41 09 955 A1	10/1992	DE			
	AL	1-253923	10/1989	JP			Abstract
	AM	2-253620	10/1990	JP			
	AN	2-272738	11/1990	JP			
	AO	5-13322	1-1993	JP			
LV	AP	6-124887	5-1994	JP			
OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)							
LV	AQ	"Method Of And Apparatus For Cleaning Substrate" Ichiro KATAKABE et al., U.S. Patent Application Serial No. 09/679,305, filed October 6, 2000.					
LV	AR	"Method Of And Apparatus For Cleaning Substrate" Ichiro KATAKABE et al., U.S. Patent Application Serial No. 10/390,600, filed March 19, 2003.					
EXAMINER LAN VINH				DATE CONSIDERED 2/28/05			

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

FORM PTO 1449 (modified)

U.S. DEPARTMENT OF COMMERCE
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U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
LV	AA	5,706,843	1-1998	Matsuo			
	AB	5,499,733	3-1996	Litvak			
	AC	6,012,966	1-2000	Ban et al.			
	AD	6,099,393	8-2000	Katagiri et al.			
	AE	6,106,907	8-2000	Yoshikawa et al.			
	AF	6,140,233	10-2000	Kwag et al.			
	AG	6,165,050	12-2000	Ban et al.			
	AH	6,180,020	1-2001	Moriyama et al.			
	AI	6,265,323	7-2001	Nakamura et al.			
	AJ	6,265,328	7-2001	Henely et al.			
	AK	6,332,835	12-2001	Nishimura et al.			
	AL	6,380,086	4-2002	Robinson et al.			
	AM	6,387,190	5-2002	Aoki et al.			
	AN	3,953,265	4-1976	Hood			
	AO	4,439,243	3-1984	Titus			
	AP	4,489,740	12-1984	Rattan et al.			
	AQ	4,510,176	4-1985	Cuthbert et al.			
	AR	4,518,678	5-1985	Allen			
	AS	4,732,785	3-1988	Brewer			
	AT	4,838,289	6-1989	Kottman et al.			
	AU	4,968,375	11-1990	Sato et al.			
LV	AV	5,176,783	1-1993	Yoshikawa			
EXAMINER	LAN VINH			DATE CONSIDERED	2/28/05		

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LV	AA	5,349,978	9-1994	Sago et al.			
	AB	5,634,980	6-1997	Tomita et al.			
	AC	5,688,411	11-1997	Kutsuzawa et al.			
LV	AD	5,783,097	7-1998	Lo et al.			
	AE						
	AF						
	AG						
	AH						
	AI						

FOREIGN PATENT DOCUMENTS

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	AJ							
	AK							
	AL							
	AM							
	AN							

OTHER DOCUMENT(S) (Including Author, Title, Date, Pertinent Pages, Etc.)

LV	AO	Co-pending application, Serial No. 09/893,624, filed June 29, 2001, entitled "Copper-Plating Liquid, Plating Method and Plating Apparatus".
	AP	
	AQ	

EXAMINER

LAN VINH

DATE CONSIDERED

2/28/05